

RoHS

COMPLIANT

AO4456-VB Datasheet N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.004 at V _{GS} = 10 V	18	6.8 nC		
30	0.005 at V _{GS} = 4.5 V	16	0.0110		

SO-8

Top View

8 D

D

6 D

5 D

S

S

S

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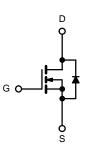
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FEATURES

- Halogen-free
- Trench Power MOSFET
- Optimized for High-Side Synchronous Rectifier Operation
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

Notebook CPU Core
High-Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	- V		
Gate-Source Voltage		V _{GS}	± 20			
	T _C = 25 °C		18			
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _C = 70 °C	1-	16			
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	15 ^{b, c}			
	T _A = 70 °C		13 ^{b, c}	А		
Pulsed Drain Current		I _{DM}	50	А		
Continuous Source-Drain Diode Current	T _C = 25 °C	1	3.8			
Commuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^{b, c}			
Single Pulse Avalanche Current	L = 0.1 mH		22			
Avalanche Energy		E _{AS}	24	mJ		
	T _C = 25 °C		4.5			
Maximum Davias Disaination	T _C = 70 °C	Pn	2.8	W		
Maximum Power Dissipation	T _A = 25 °C	ГD	2.5 ^{b, c}	VV		
	T _A = 70 °C		1.6 ^{b, c}			
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	22	28	0/11	

Notes:

a. Base on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85 °C/W.



Symbol	Test Conditions	Min.	Тур.	Max.	1 Init	
			1961	max.	Unit	
1				T		
V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V	
$\Delta V_{DS}/T_{J}$	lь = 250 цА		28		mV/°C	
$\Delta V_{GS(th)}/T_J$	5		- 6			
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.0		3.0	V	
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
'DSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	20			А	
Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11 \text{ A}$	0.004				
r DS(on)	V _{GS} = 4.5 V, I _D = 10 A		0.005		Ω	
9 _{fs}	V _{DS} = 15 V, I _D = 11 A		52		S	
1 1				1	4	
C _{iss}			820		pF	
	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		195			
	20 00		73			
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 11 A		15	23	-	
Qg	56 56 5		6.8	10.2	nC	
Q _{qs}	V _{DS} = 15 V, V _{GS} = 5 V, I _D = 11 A		2.5			
Ĵ			2.3			
Ĵ.	f = 1 MHz	0.36	1.8	3.6	Ω	
<u> </u>			16	24		
t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$		12	18	-	
t _{d(off)}	$I_D \cong 9 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$		16	24		
t _f			10	20		
t _{d(on)}			8	16	ns	
t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$		10	20	-	
t _{d(off)}	$I_D \cong 9 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$		16	24		
	-		8	15		
					<u> </u>	
	T _C = 25 °C			25		
I _{SM}				50	A	
-	I _S = 9 A		0.8	1.2	V	
			15	30	ns	
			-	12	nC	
	$I_F = 9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$					
					ns	
	$\begin{array}{c c} \Delta V_{GS(th)}/T_J \\ \hline V_{GS(th)} \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{D(on)} \\ \hline R_{DS(on)} \\ \hline g_{fs} \\ \hline \\ \hline \\ C_{iss} \\ \hline \\ C_{css} \\ \hline \\ C_{css} \\ \hline \\ \\ C_{rss} \\ \hline \\ \\ Q_g \\ \hline \\ \\ Q_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ (A(on)) \\ \hline \\ t_r \\ \hline \\ t_{d(onf)} \\ \hline \\ t_f \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{S} \\ \hline \\ \end{bmatrix} $	$\begin{array}{ c c c c c c } & I_D = 250 \ \mu A \\ \hline I_D = 250 \ \mu A \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 30 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & I_D \cong 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline t_d(on) & t_r & V_{DD} = 15 \ V, \ R_L = 1.4 \ \Omega \\ \hline t_d(off) & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline t_{S} & I_S \ T_{S} \ D_{S} \ T_{S} $	$\begin{array}{ c c c c c c } & I_D = 250 \ \mu A & & & & & \\ \hline I_D = 250 \ \mu A & & & & & & \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, I_D = 250 \ \mu A & & & & & & \\ \hline I_{GSS} & V_{DS} = 0 \ V, V_{GS} = 4 \ 20 \ V & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 10 \ V, I_D = 11 \ A & & & & \\ \hline V_{CS} = 15 \ V, I_D = 11 \ A & & & & \\ \hline \hline C_{rss} & & & & \\ \hline \hline C_{rss} & & & & \\ \hline C_{rss} & & & & \\ \hline V_{DS} = 15 \ V, V_{GS} = 0 \ V, \ I_D = 11 \ A & & & \\ \hline Q_g & & & & \\ \hline V_{DS} = 15 \ V, V_{GS} = 10 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & & \\ \hline V_{DS} = 15 \ V, V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & \\ \hline I_D \cong 9 \ A, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline \hline U_D \cong 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega & & \\ \hline I_d(off) & & & \\ \hline I_D \cong 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega & & \\ \hline I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega & & \\ \hline \hline I_d(off) & & & \\ \hline I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega & & \\ \hline \hline I_S & & & \\ \hline V_{SD} & & & \\ \hline I_S = 9 \ A & & \\ \hline V_{SD} & & & \\ \hline I_F = 9 \ A, \ dI/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C & & \\ \hline \hline \hline \end{array}$	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	

Notes:

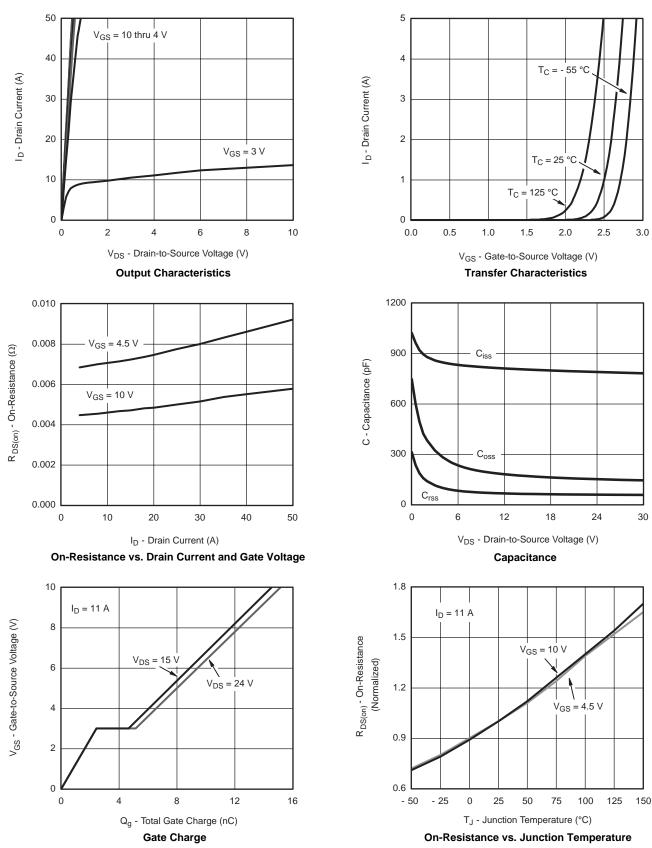
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

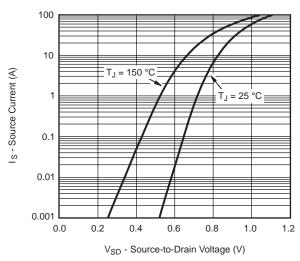




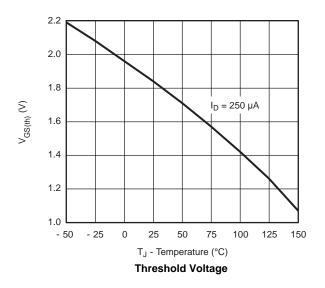


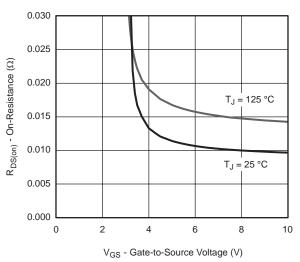


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





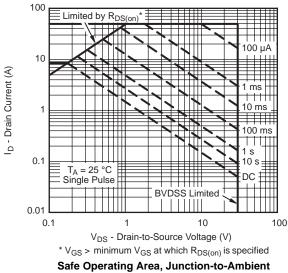




On-Resistance vs. Gate-to-Source Voltage

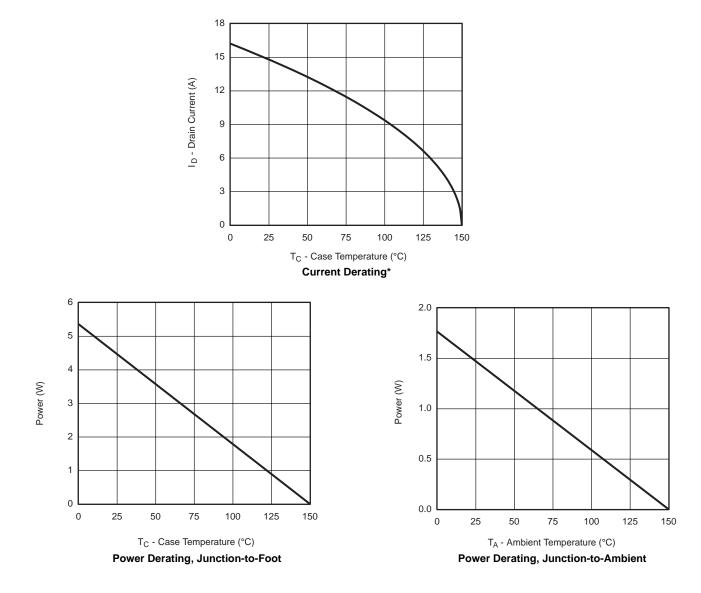






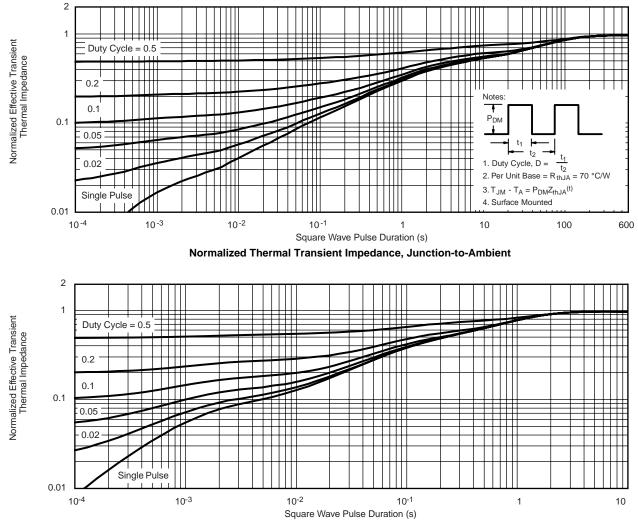


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot





SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

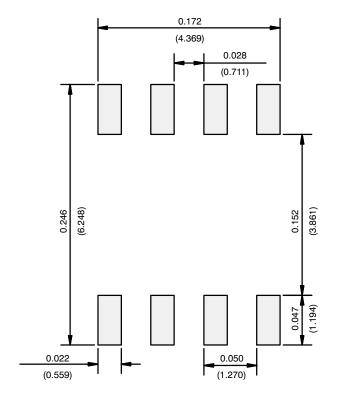




	MILLIMETERS		INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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